[0089] An integrated circuit has a metal layer that includes conductors to provide interconnectivity for components of the integrated circuit chip. The metal layer is divided into at least two sections, such that a first section has a preferred direction and the second section has a preferred wiring direction that is different from the first preferred direction. The first and second preferred directions on a single metal layer may consist of any direction. The metal layer may be divided into more than two sections, wherein each section has a preferred wiring direction. Wiring geometries for multi-level metal layers are also disclosed

Figures

IC (Top View)

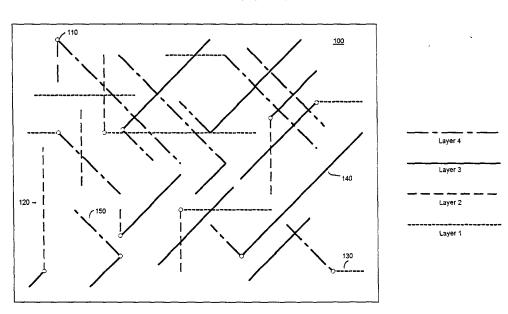


Figure 1a

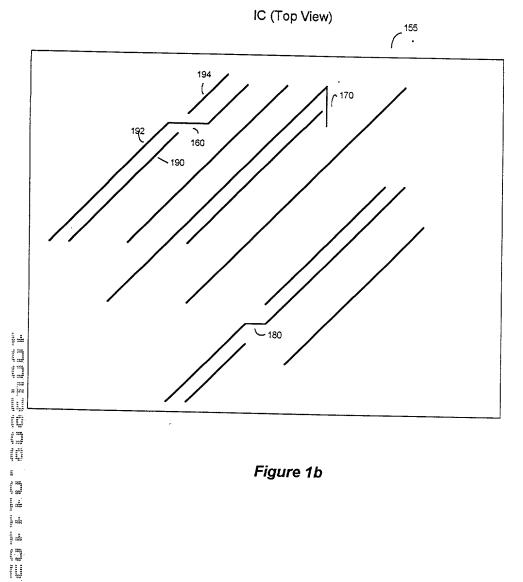
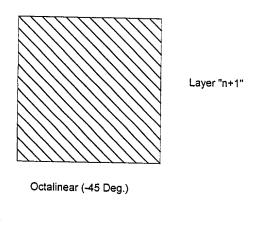


Figure 1b



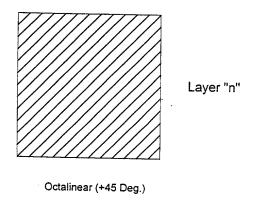
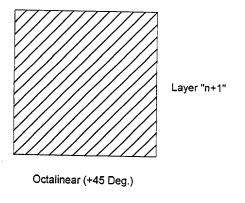


Figure 2a

2



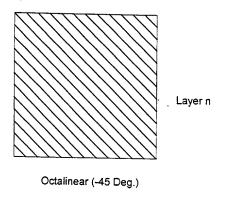
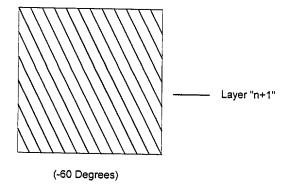


Figure 2b



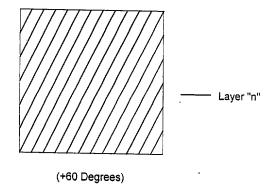
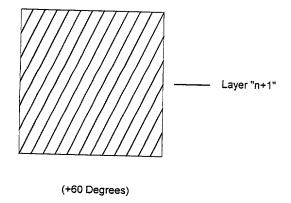


Figure 3a



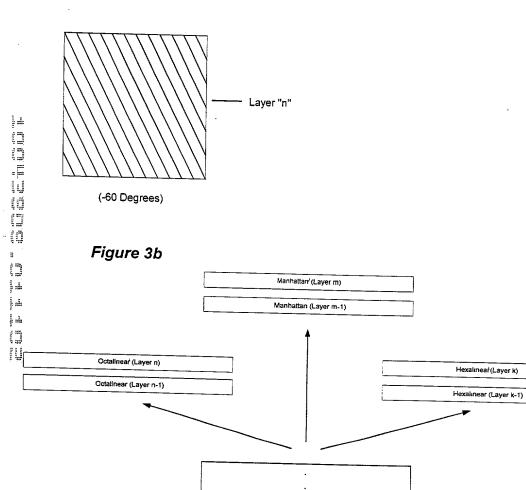
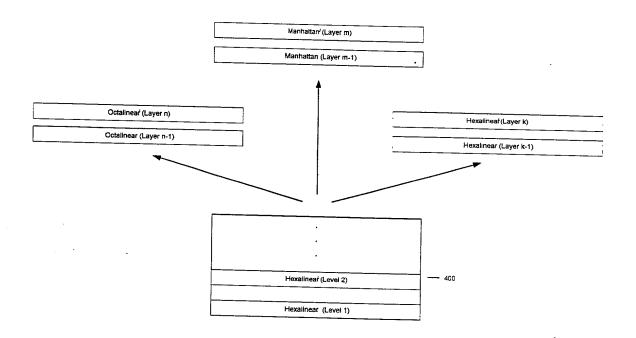


Figure 4a

Octalinear (Level 2)

Octalinear (Level 1)



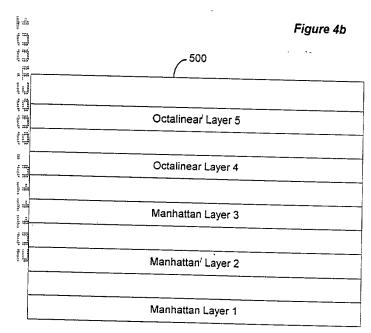


Figure 5a

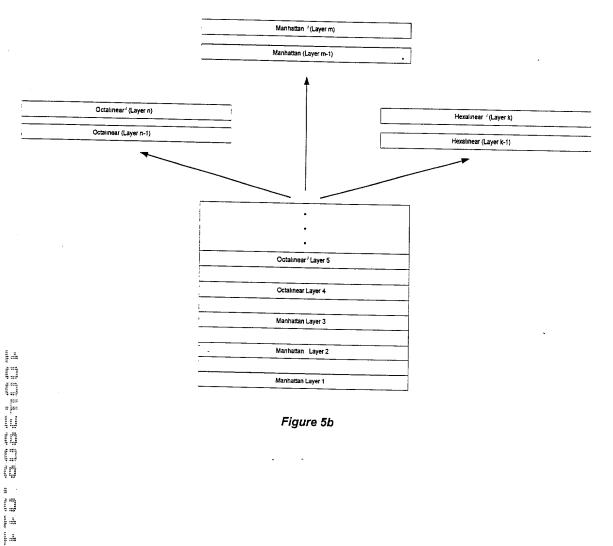
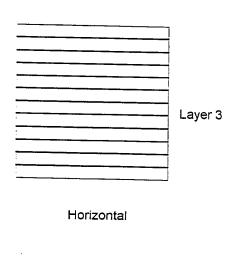
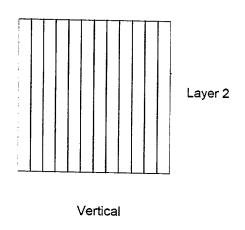


Figure 5b





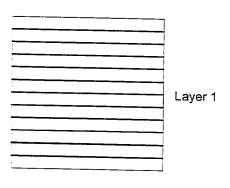
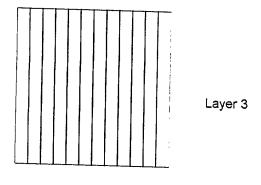


Figure 6a

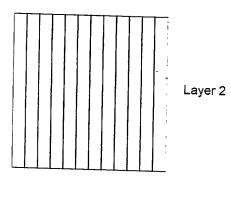
Horizontal

Figure 6b

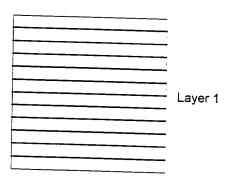
Vertical



Vertical



Vertical



Horizontal

Figure 6c

Horizontal	Layer 3
Horizontal	Layer 2
	Layer 1

Figure 6d

Vertical

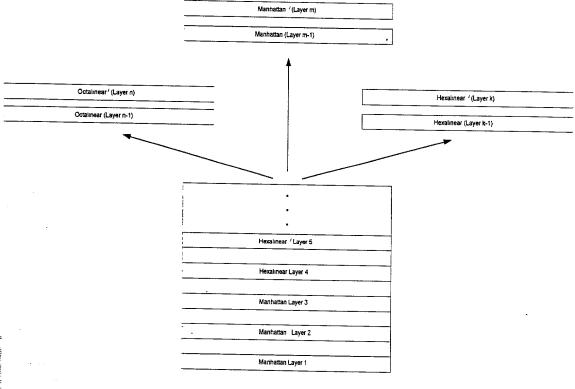


Figure 7

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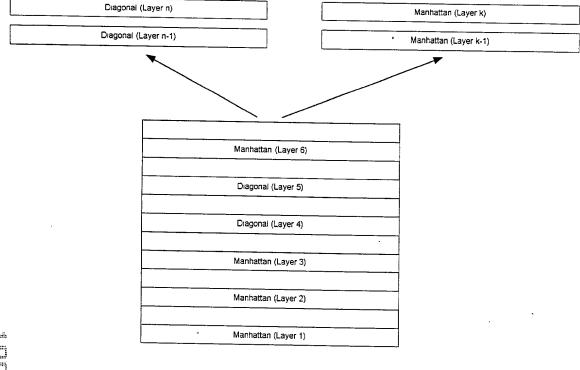


Figure 8

The state of the s

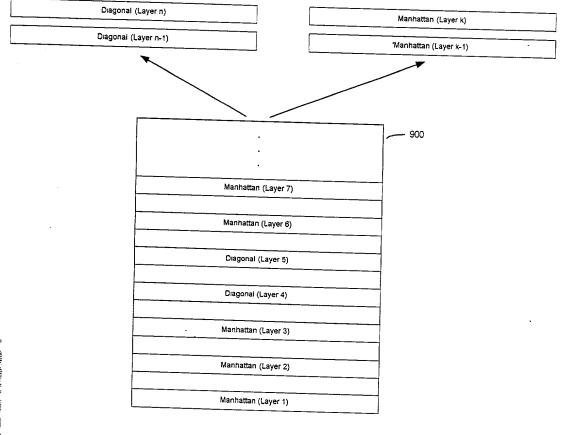


Figure 9

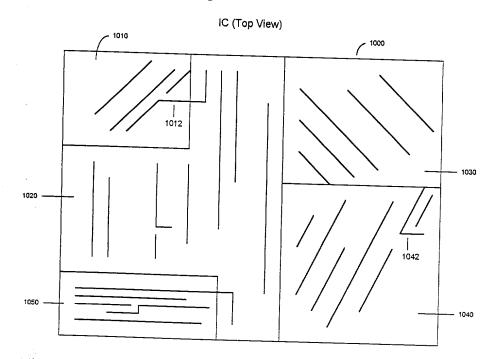
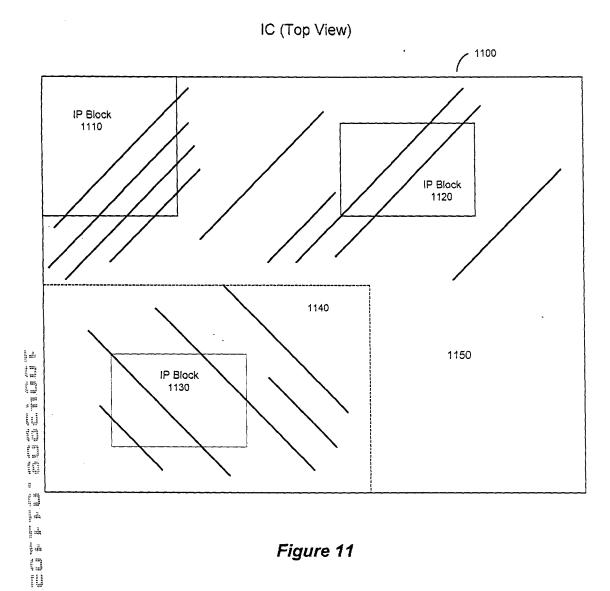


Figure 10



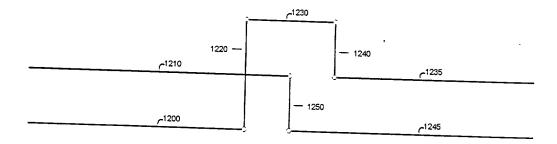
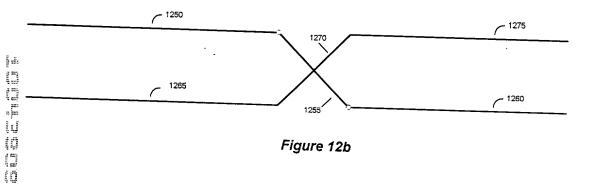


Figure 12a

Prior Art



H. H. H. H. H.

Figure 12b

Layer "n+1" (Top View)

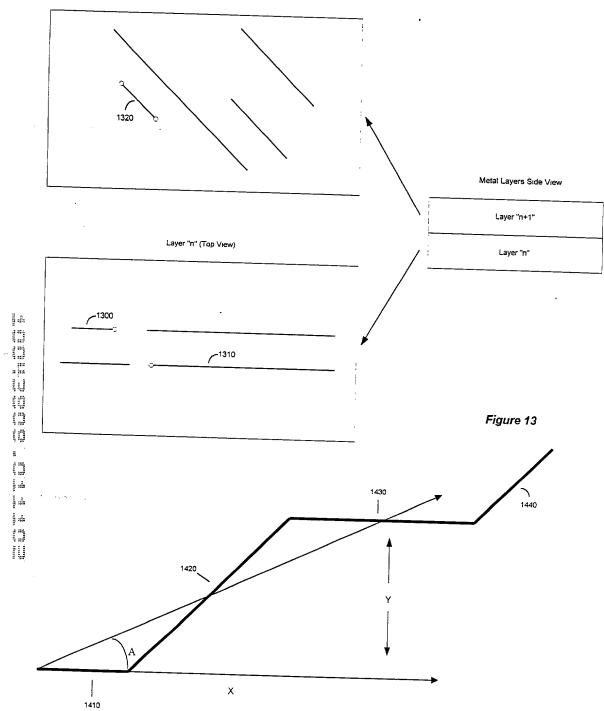


Figure 14

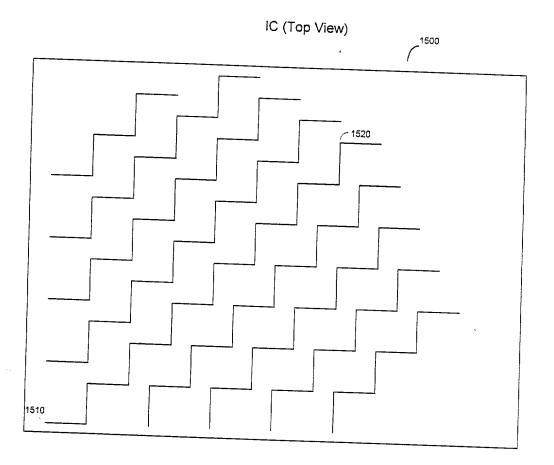


Figure 15

